

UC1871 UC2871 UC3871

# Resonant Fluorescent Lamp Driver

# **FEATURES**

- 1μA ICC when Disabled
- PWM Control for LCD Supply
- Zero Voltage Switched (ZVS) on Push-Pull Drivers
- Open Lamp Detect Circuitry
- 4.5V to 20V Operation
- Non-saturating Transformer Topology
- Smooth 100% Duty Cycle on Buck PWM and 0% to 95% on Flyback PWM

# **DESCRIPTION**

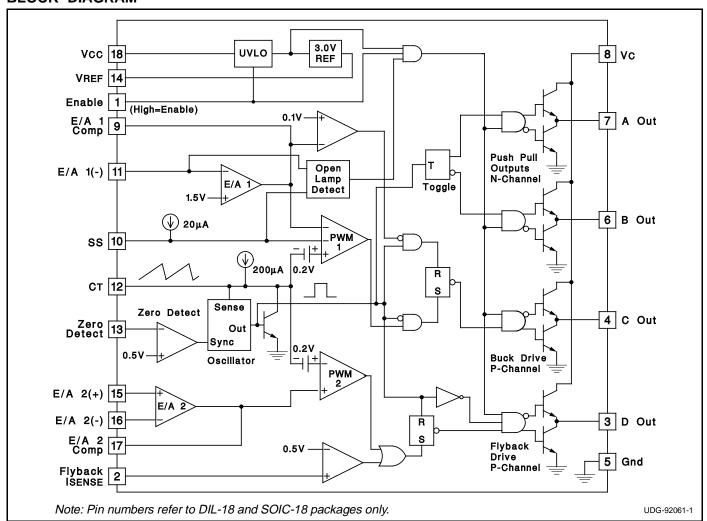
The UC1871 Family of IC's is optimized for highly efficient fluorescent lamp control. An additional PWM controller is integrated on the IC for applications requiring an additional supply, as in LCD displays. When disabled the IC draws only  $1\mu A,$  providing a true disconnect feature, which is optimum for battery powered systems. The switching frequency of all outputs are synchronized to the resonant frequency of the external passive network, which provides Zero Voltage Switching on the Push-Pull drivers.

Soft-Start and open lamp detect circuitry have been incorporated to minimize component stress. An open lamp is detected on the completion of a soft-start cycle.

The Buck controller is optimized for smooth duty cycle control to 100%, while the flyback control ensures a maximum duty cycle of 95%.

Other features include a precision 1% reference, under voltage lockout, flyback current limit, and accurate minimum and maximum frequency control.

#### **BLOCK DIAGRAM**



# ABSOLUTE MAXIMUM RATINGS Analog Inputs -0.3 to +10V Vcc, Vc Voltage +20V Zero Detect Input Current +10mA High Impedance Source +10mA Zero Detect Low Impedance Source +20V Power Dissipation at TA = 25°C 1W

DIL-18, SOIC-18 (TOP VIEW) J or N, DW Package						
Enable 1		18 Vcc				
Flyback ISENSE 2	-	17 E/A 2 Comp				
D Out 3		16 E/A 2(-)				
C Out 4		15 E/A 2(+)				
Gnd 5		14 VREF				
B Out 6		13 Zero Detect				
A Out 7		12 CT				
Vc 8		11 E/A 1(-)				
E/A 1 Comp 9	1	10 SS				

Note 1: Currents are positive into, negative out of the specified terminal.

Note 2: Consult Packaging Section of Databook for thermal limitations and considerations of package.

# **CONNECTION DIAGRAMS**

PLCC-20 (Top View)	PACKAGE PIN FU	INCTION
Q Package	FUNCTION	PIN
	Gnd	1
	B Out	2
	A Out	3
	Vc	4
3 2 1 20 19	E/A 1 Comp	5
18	SS	6
	E/A 1(-)	7
[5 17]	N/C	8
	Ст	9
<b>15</b>	Zero Detect	10
8 14	N/C	11
9 10 11 12 13	VREF	12
	E/A 2(+)	13
	E/A 2(-)	14
	E/A 2 Comp	15
	Vcc	16
	Enable	17
	Flyback Isense	18
	D Out	19
	C Out	20

# **ELECTRICAL CHARACTERISTICS** Unless otherwise stated, these parameters apply for TA = -55°C to +125°C for the UC1871; -25°C to +85°C for the UC2871; 0°C to +70°C for the UC3871; Vcc = 5V, Vc = 15V, VENABLE = 5V, CT = 1nF, Zero Det = 1V.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Reference Section					
Output Voltage	TJ=25°C	2.963	3.000	3.037	V
	Overtemp	2.940	3.000	3.060	V
Line Regulation	Vcc = 4.75V to 18V			10	mV
Load Regulation	Io=0 to -5mA			10	mV
Oscillator Section					
Free Running Freq	TJ=25°C	57	68	78	kHz
Max Sync Frequency	TJ=25°C	160	200	240	kHz
Charge Current	VCT = 1.5V	180	200	220	μΑ
Voltage Stability				2	%
Temperature Stability			4	8	%
Zero Detect Threshold		0.46	0.5	0.56	V
Error Amp 1 Section					
Input Voltage	Vo = 2V	1.445	1.475	1.505	V
Input Bias Current			-0.4	-2	μΑ
Open Loop Gain	Vo = 0.5  to  3V	65	90		dB
Output High	VEA(-) = 1.3V	3.1	3.5	3.9	V
Output Low	VEA(-) = 1.7V		0.1	0.2	V
Output Source Current	VEA(-) = 1.3V, Vo = 2V	-350	-500		μΑ
Output Sink Current	VEA(-) = 1.7V, Vo = 2V	10	20		mA
Common Mode Range		0		VIN-1V	V
Unity Gain Bandwidth	T <sub>J</sub> = 25°C (Note 4)		1		MHz
Maximum Source Impedance	Note 5			100k	Ω

# **ELECTRICAL CHARACTERISTICS (cont.)**

Unless otherwise stated, these parameters apply for TA = -55°C to +125°C for the UC1871; -25°C to +85°C for the UC2871; 0°C to +70°C for the UC3871; Vcc = 5V, Vc = 15V, VENABLE = 5V, CT = 1nF, Zero Det = 1V.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Open Lamp Detect Section					
Soft Start Threshold	VEA(-) = 0V	2.9	3.4	3.8	V
Error Amp Threshold	Vss = 4.2V	0.7	1.0	1.3	V
Soft Start Current	Vss = 2V	10	20	40	μΑ
Error Amp 2 Section		•			
Input Offset Voltage	Vo = 2V		0	10	mV
Input Bias Current			-0.2	-1	μΑ
Input Offset Current				0.5	μΑ
Open Loop Gain	Vo = 0.5 to 3V	65	90		dB
Output High	VID = 100mV, VO = 2V	3.6	4	4.4	V
Output Low	VID = -100mv, Vo = 2V		0.1	0.2	V
Output Source Current	VID = 100mV, VO = 2V	-350	-500		μΑ
Output Sink Current	VID = -100mV, VO = 2V	10	20		mA
Common Mode Range		0		VIN-2V	V
Unity Gain Bandwidth	T <sub>J</sub> = 25°C (Note 4)		1		MHz
Isense Section		•			
Threshold		0.475	0.525	0.575	V
Output Section		•			•
Output Low Level	IOUT = 0, Outputs A and B		0.05	0.2	V
·	IOUT = 10mA		0.1	0.4	V
	IOUT = 100mA		1.5	2.2	V
Output High Level	IOUT = 0, Outputs C and D	14.7	14.9		V
	IOUT = -10mA	13.5	14.3		V
	IOUT = -100mA	12.5	13.5		V
Rise Time	T <sub>J</sub> = 25°C, Cl = 1nF(Note 4)		30	80	ns
Fall Time	T <sub>J</sub> = 25°C, Cl = 1nF(Note 4)		30	80	ns
Output Dynamics		•			•
Out A and B Duty Cycle		48	49.9	50	%
Out C Max Duty Cycle	VEA1(-) = 1V	100			%
Out C Min Duty Cycle	VEA1(-) = 2V			0	%
Out D Max Duty Cycle	VEA2(+)- VEA2(-) = 100mV		92	96	%
Out D Min Duty Cycle	VEA2(+)- VEA2(-) = -100mV			0	%
Under Voltage Lockout Section		•			•
Start-Up Threshold		3.7	4.2	4.5	V
Hysterisis		120	200	280	mV
Enable Section			-		
Input High Threshold		2			V
Input low Threshold				0.8	V
Input Current	VENABLE = 5V		150	400	μΑ
Supply Current Section					
VCC Supply Current	Vcc = 20V		8	14	mA
VC Supply Current	Vc=20V		7	12	mA
ICC Disabled	VCC = 20V, VENABLE = 0V		1	10	μΑ

Note 3: Unless otherwise specified, all voltages are with respect to ground.

Currents are positive into, and negative out of the specified terminal.

Note 4: Guaranteed by design but not 100% tested in production.

Note 5: Impedance below specified maximum guarantees proper operation of the Open Lamp Detect.

# TYPICAL APPLICATION

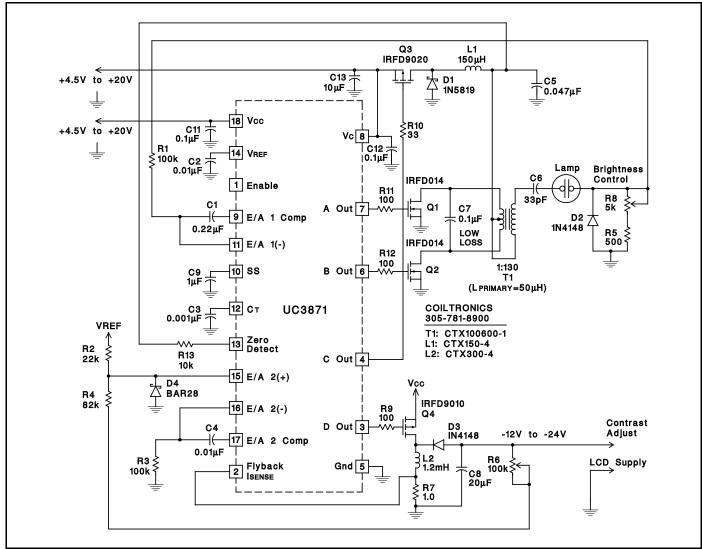


Figure 1

#### APPLICATION INFORMATION

Figure 1 shows a complete application circuit using the UC3871 Resonant Fluorescent lamp and LCD driver. The IC provides all drive, control and housekeeping functions to implement CCFL and LCD converters. The buck output voltage (transformer center-tap) provides the zero crossing and synchronization signal. The LCD supply modulator is also synchronized to the resonant tank.

The buck modulator drives a P-channel MOSFET directly, and operates over a 0-100% duty-cycle range. The modulation range includes 100%, allowing operation with minimal headroom. The LCD supply modulator also directly drives a P-channel MOSFET, but it's duty-cycle is limited to 95% to prevent flyback supply foldback.

The oscillator and synchronization circuitry are shown in Figure 2. The oscillator is designed to synchronize over a 3:1 frequency range. In an actual application however, the frequency range is only about 1.5:1. A zero detect

comparator senses the primary center-tap voltage, generating a synchronization pulse when the resonant waveform falls to zero. The actual threshold is 0.5 volts, providing a small amount of anticipation to offset propagation delay.

The synchronization pulse width is the time that the 4mA current sink takes to discharge the timing capacitor to 0.1 volts. This pulse width sets the LCD supply modulator minimum off time, and also limits the minimum linear control range of the buck modulator. The 200µA current source charges the capacitor to a maximum of 3 volts. A comparator blanks the zero detect signal until the capacitor voltage exceeds 1 volt, preventing multiple synchronization pulse generation and setting the maximum frequency. If the capacitor voltage reaches 3 volts (a zero detection has not occurred) an internal clock pulse is generated to limit the minimum frequency.

# **APPLICATION INFORMATION (cont.)**

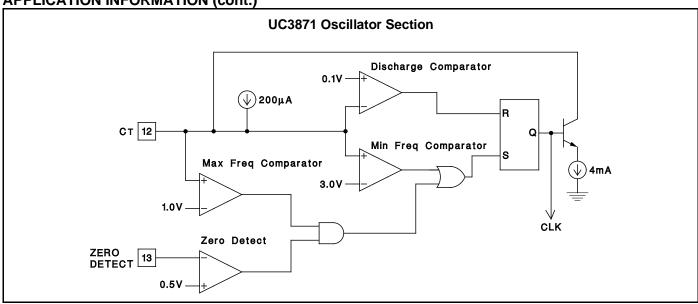


Figure 2

A unique protection feature incorporated in the UC3871 is the Open Lamp Detect circuit. An open lamp interrupts the current feedback loop and causes very high secondary voltage. Operation in this mode will usually breakdown the transformer's insulation, causing permanent damage to the converter. The open lamp detect circuit, shown in Figure 3 senses the lamp current feedback signal at the error amplifiers input, and shuts down the outputs if insufficient signal is present. Soft-start circuitry limits initial turn-on currents and blanks the open lamp detect signal.

Other features are included to minimize external circuitry

requirements. A logic level enable pin shuts down the IC, allowing direct connection to the battery. During shutdown, the IC typically draws less than  $1\mu A.$  The UC3871, operating from 4.5V to 20V, is compatible with almost all battery voltages used in portable computers. Under-voltage lockout circuitry disables operation until sufficient supply voltage is available, and a 1% voltage reference insures accurate operation. Both inputs to the LCD supply error amplifier are uncommitted, allowing positive or negative supply loop closure without additional circuitry. The LCD supply modulator also incorporates cycle-bycycle current limiting for added protection.

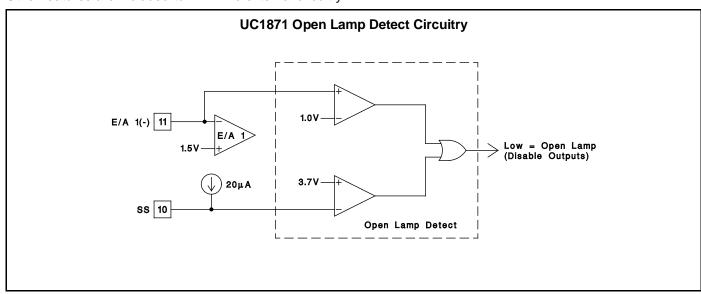


Figure 3

# **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

	Applications	
amplifier.ti.com	Audio	www.ti.com/audio
dataconverter.ti.com	Automotive	www.ti.com/automotive
dsp.ti.com	Broadband	www.ti.com/broadband
interface.ti.com	Digital Control	www.ti.com/digitalcontrol
logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
microcontroller.ti.com	Security	www.ti.com/security
www.ti.com/lpw	Telephony	www.ti.com/telephony
	Video & Imaging	www.ti.com/video
	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Audio Audio Audio Automotive Broadband Digital Control Military Optical Networking Security Telephony Video & Imaging

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated







# **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finisl	n MSL Peak Temp <sup>(3)</sup>
5962-9462201MVA	OBSOLETE			18		TBD	Call TI	Call TI
5962-9462201Q2A	OBSOLETE	LCCC	FK	20		TBD	Call TI	Call TI
UC1871J	OBSOLETE	CDIP	J	18		TBD	Call TI	Call TI
UC1871J883B	OBSOLETE	CDIP	J	18		TBD	Call TI	Call TI
UC1871L883B	OBSOLETE	TO/SOT	L	20		TBD	Call TI	Call TI
UC2871DW	ACTIVE	SOIC	DW	18	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2871DWG4	ACTIVE	SOIC	DW	18	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2871DWTR	ACTIVE	SOIC	DW	18	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2871DWTRG4	ACTIVE	SOIC	DW	18	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC2871N	ACTIVE	PDIP	N	18	20	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC2871NG4	ACTIVE	PDIP	N	18	20	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC2871Q	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC2871QG3	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC2871QTR	ACTIVE	PLCC	FN	20	1000	TBD	CU SN	Level-2-220C-1 YEAR
UC3871DW	ACTIVE	SOIC	DW	18	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3871DWG4	ACTIVE	SOIC	DW	18	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3871DWTR	ACTIVE	SOIC	DW	18	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3871DWTRG4	ACTIVE	SOIC	DW	18	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR
UC3871N	ACTIVE	PDIP	N	18	20	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC3871NG4	ACTIVE	PDIP	N	18	20	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type
UC3871Q	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC3871QG3	ACTIVE	PLCC	FN	20	46	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC3871QTR	ACTIVE	PLCC	FN	20	1000	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR
UC3871QTRG3	ACTIVE	PLCC	FN	20	1000	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.



# PACKAGE OPTION ADDENDUM

7-May-2007

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# 14 LEADS SHOWN



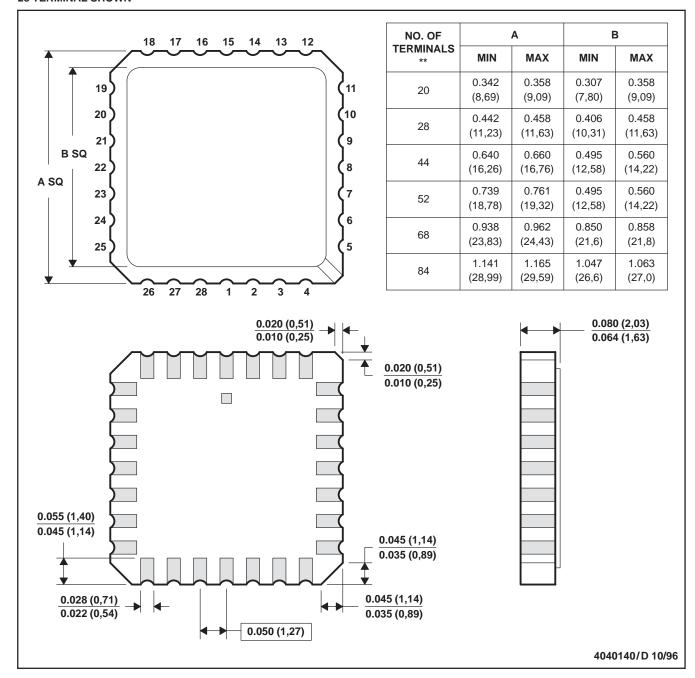
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# FK (S-CQCC-N\*\*)

# **28 TERMINAL SHOWN**

# **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



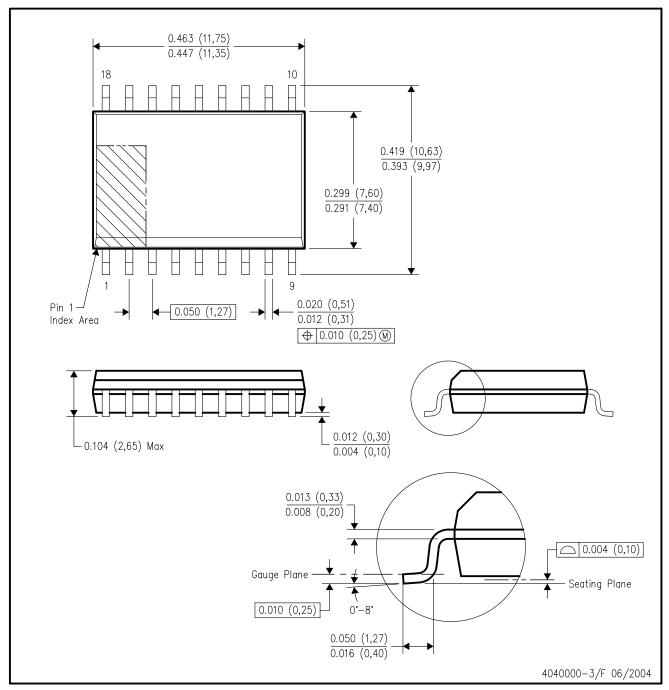
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# DW (R-PDSO-G18)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

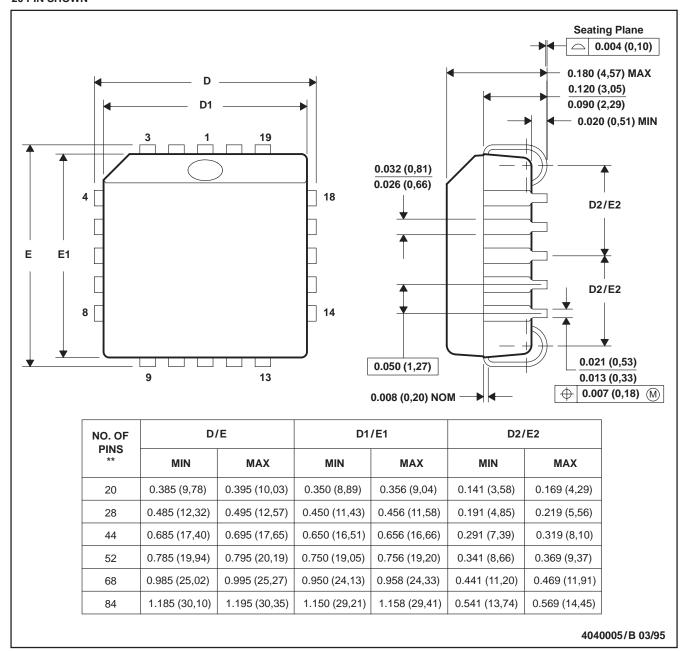
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AB.



# FN (S-PQCC-J\*\*)

#### 20 PIN SHOWN

# PLASTIC J-LEADED CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-018

# **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

	Applications	
amplifier.ti.com	Audio	www.ti.com/audio
dataconverter.ti.com	Automotive	www.ti.com/automotive
dsp.ti.com	Broadband	www.ti.com/broadband
interface.ti.com	Digital Control	www.ti.com/digitalcontrol
logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
microcontroller.ti.com	Security	www.ti.com/security
www.ti.com/lpw	Telephony	www.ti.com/telephony
	Video & Imaging	www.ti.com/video
	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw  Audio Audio Audio Audio Automotive Broadband Digital Control Military Optical Networking Security Telephony Video & Imaging

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2007, Texas Instruments Incorporated